

3A, 50V - 1000V High Efficient Surface Mount Rectifier

FEATURES

- Low power loss, high efficiency
- Low forward voltage drop
- Low profile package
- Fast switching for high efficiency
- Ideal for automated placement
- Glass passivated chip junction
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APF	LICA	TION	IS
------------	------	------	----

- Switching mode power supply (SMPS)
- Adapters
- Monitor
- TV

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.093g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I _F	3	Α			
V_{RRM}	50 - 1000	>			
I _{FSM}	100	Α			
T _{J MAX}	150 °C				
Package	DO-214AA (SMB)				
Configuration	Single die				







DO-214AA (SMB)



	SYMBOL	HS	HS	HS	HS	HS	HS	HS	HS		
PARAMETER		ЗАВ	3BB	3DB	3FB	3GB	3JB	3KB	3МВ	UNIT	
Marking and on the daving		HS	HS	HS	HS	HS	HS	HS	HS		
Marking code on the device		3AB	3BB	3DB	3FB	3GB	3JB	3KB	3МВ		
Repetitive peak reverse voltage	V_{RRM}	50	100	200	300	400	600	800	1000	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	210	280	420	560	700	V	
Forward current	I _F				(3				Α	
Surge peak forward current 8.3ms single half sine-wave superimposed on rated load	I _{FSM}	100					А				
Junction temperature	T _J - 55 to +150			°C							
Storage temperature T _{STG} - 55 to +150				°C							

1



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	60	°C/W		

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
(1)	HS3AB HS3BB HS3DB HS3FB		.,	-	1.0	V
Forward voltage ⁽¹⁾	HS3GB	-	V _F	-	1.3	V
	HS3JB HS3KB HS3MB			-	1.7	V
Developed Outstand V (2)		$T_J = 25^{\circ}C$	_	-	10	μA
Reverse current @ rated V _R ⁽²⁾		T _J = 100°C	l _R	-	250	μΑ
Junction capacitance	HS3AB HS3BB HS3DB HS3FB HS3GB	1MHz, V _R = 4.0V	CJ	80	-	pF
	HS3JB HS3KB HS3MB			50	-	pF
Reverse recovery time	HS3AB HS3BB HS3DB HS3FB HS3GB	I _F = 0.5A, I _R = 1.0A, I _{rr} = 0.25A	t _{rr}	-	50	ns
	HS3JB HS3KB HS3MB			-	75	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING			
HS3xB	DO-214AA (SMB)	3,000 / Tape & Reel			

2

Notes:

1. "x" defines voltage from 50V(HS3AB) to 1000V(HS3MB)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

Fig.2 Typical Junction Capacitance

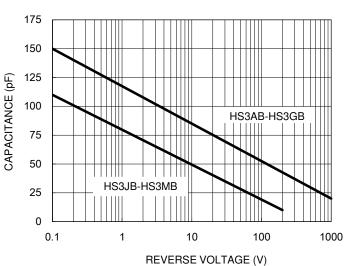


Fig.3 Typical Reverse Characteristics

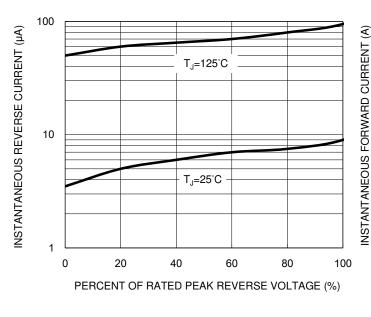
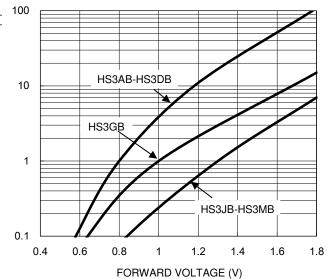


Fig.4 Typical Forward Characteristics





CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.5 Maximum Non-Repetitive Forward Surge Current

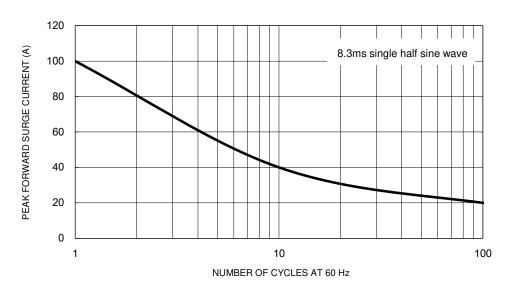
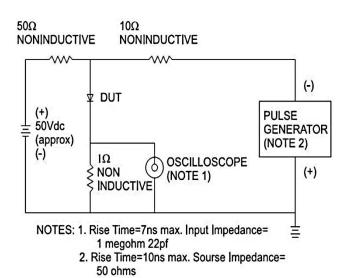
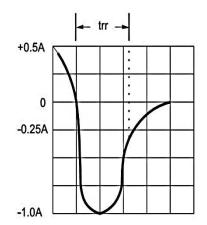


Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

4



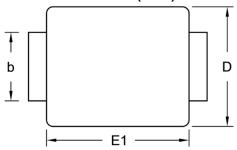


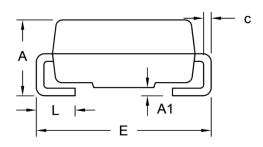




PACKAGE OUTLINE DIMENSIONS

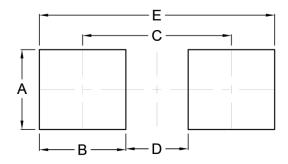
DO-214AA (SMB)





DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min.	Max.	Min.	Max.	
Α	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
С	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

MARKING DIAGRAM



= Marking Code P/N G = Green Compound

ΥW = Date Code F = Factory Code

5



Taiwan Semiconductor

Notice

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.